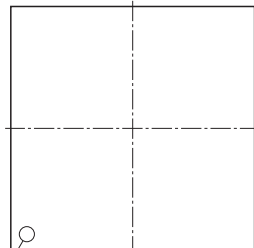


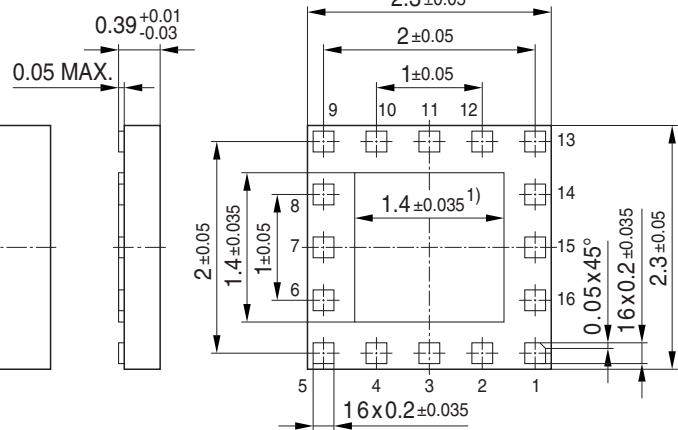
Top view



Pin 1 marking

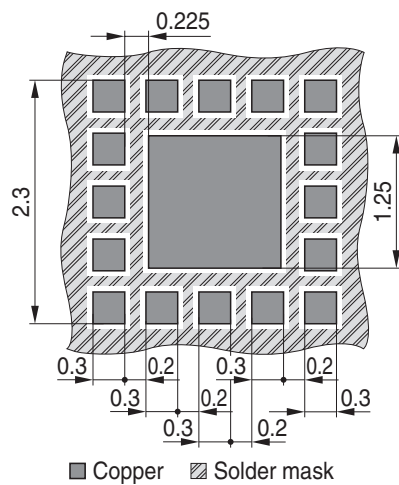
1) Dimension applies to plated terminals

Bottom view

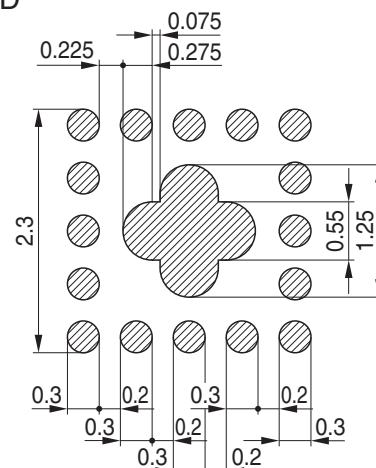


Soldering Type: Reflow Soldering

NSMD

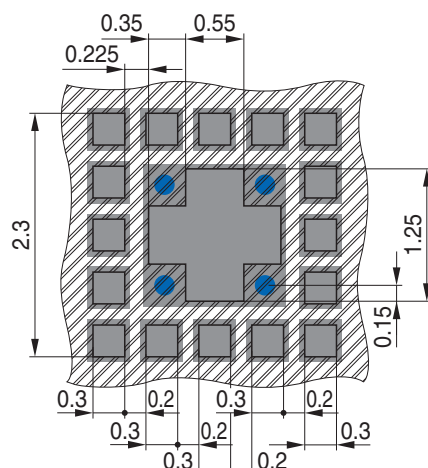


■ Copper ▨ Solder mask



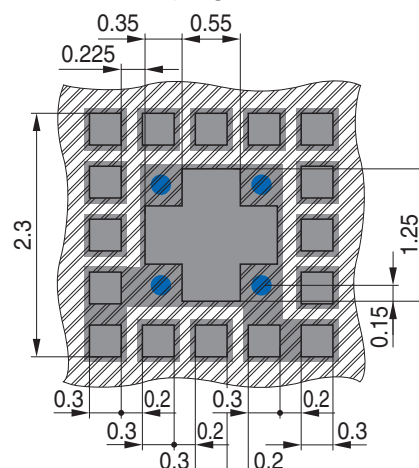
▣ Stencil apertures

SMD - V1

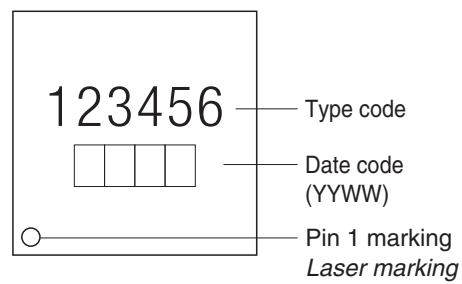


■ Copper ▨ Solder mask ■ Vias top to first inner layer

SMD - V2 (e.g. BGA734L16)



Marking Layout



Tape and Reel

Reel ø180 mm: 7.500 Pieces/Reel
Reels/Box: 1

